

# **SMD Crystal Units Seam Sealed Ceramic**

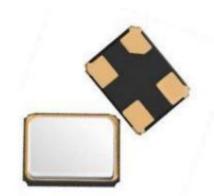
Size: 1612 (1.6x1.2x0.35mm) 24MHz to 54MHz / 10ppm-20ppm

#### **Features**

- 1612 size ultra miniature and lightweight SMD crystal units with low profile of 0.35mm
- Frequency range from 24MHz to 54MHz
- High precision and high frequency stability
- High reliable environmental performance
- Automatic mounting and reflow soldering
- Applications: Wireless Communications, Smartphone,

Wearable Devices, etc.

• RoHS Compliant & Pb Free



### **Standard Specification**

Item /Type	7Y (1612 Crystal)			
Frequency Range	24~54 MHz			
Frequency Tolerance	±10ppm, ±20ppm			
Frequency Stability	±10ppm, ±20ppm			
Load Capacitance	8pF, 10pF, or custom			
Operating Temperature	-20~+75°C, or custom			
Storage Temperature	-55~+125°C			
Drive Level	1~200μW (50μW Typ.) .			
Shunt Capacitance	5.0pF Max.			
Ageing (at 25°C)	±3ppm first year			
Packing Unit	3000pcs. /Reel			

### **Equivalent Series Resistance**

Fundamental					
24~30 MHz	100 Ω Max.				
30~54 MHz	80 Ω Max.				

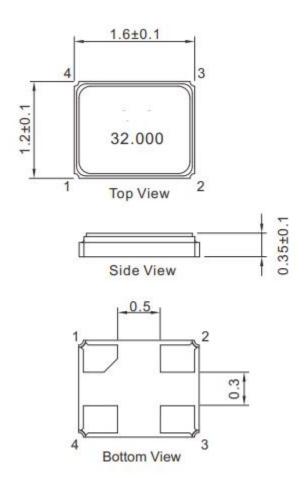


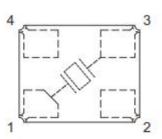
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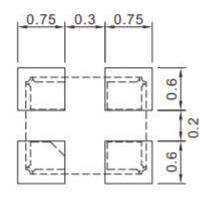
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### **Dimensions (mm)**





Top View Crystal Connection



Top View Suggested Layout

## Part ordering information

X	-7Y	-32.000	-10	-20	-80	-C	-10
	Series	Frequency	Load Capacitance	Frequency tolerance	ESR	Operating Temperature	Frequency stability
		e.g.	e.g.	e.g.	e.g.	e.g.	e.g.
		32000 = 32 MHz	10 = 10 pF	20 = 20ppm	$80 = 80 \Omega$	$A = -10 \sim +60^{\circ}$	10 = 10ppm
						B = -20~+70°C	
						C = -40~+85°C	
						D = -40~+105°C	
						E = -55~+125°C	



## X-7Y Series

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